

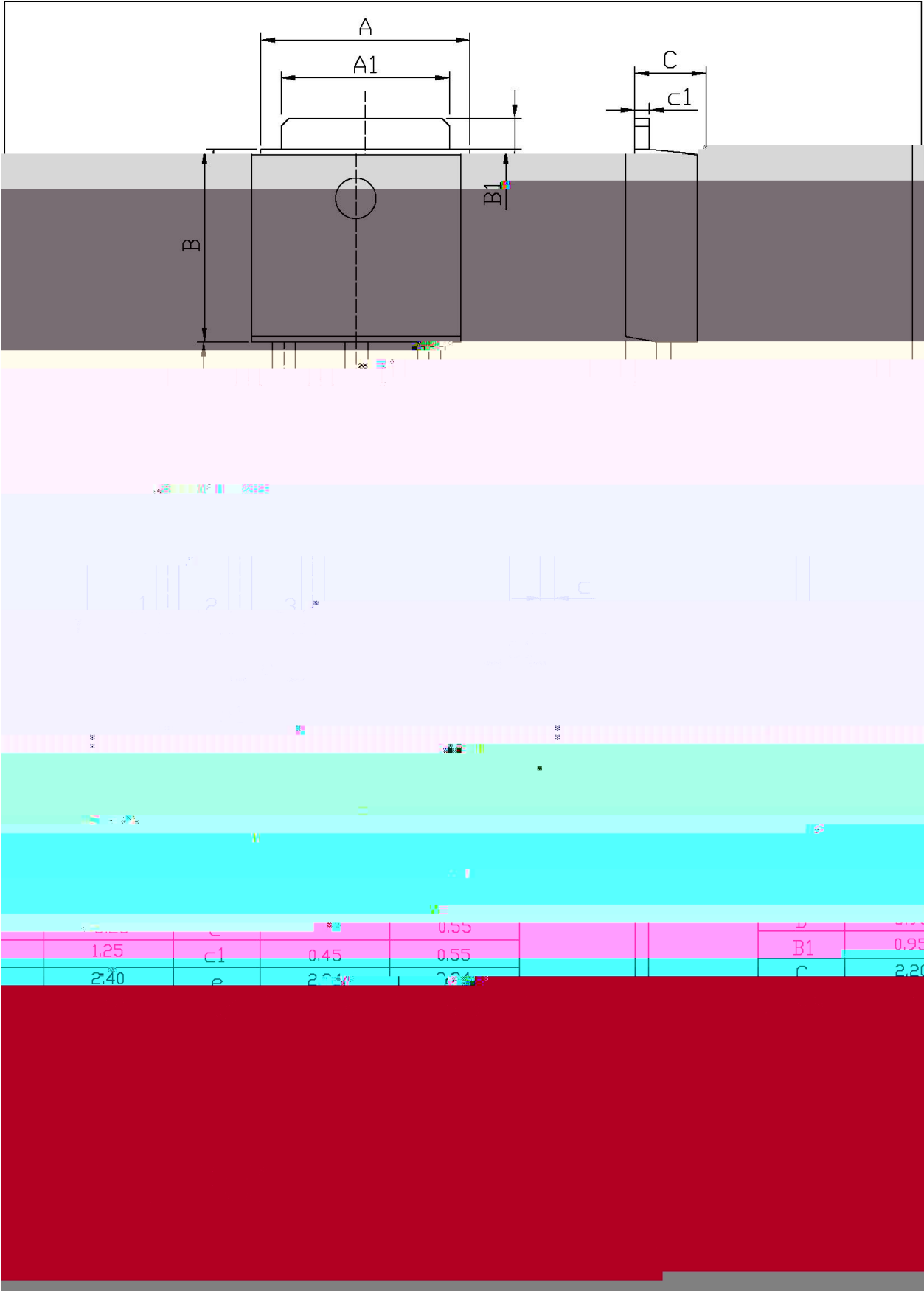
WR0584 ММ Ё QSQ Æ М ы s ll 1 Silicon NPN transistor in a TO-251 Plastic Package.

лъ WLS75FL Й ´
Complement to TIP42CI.

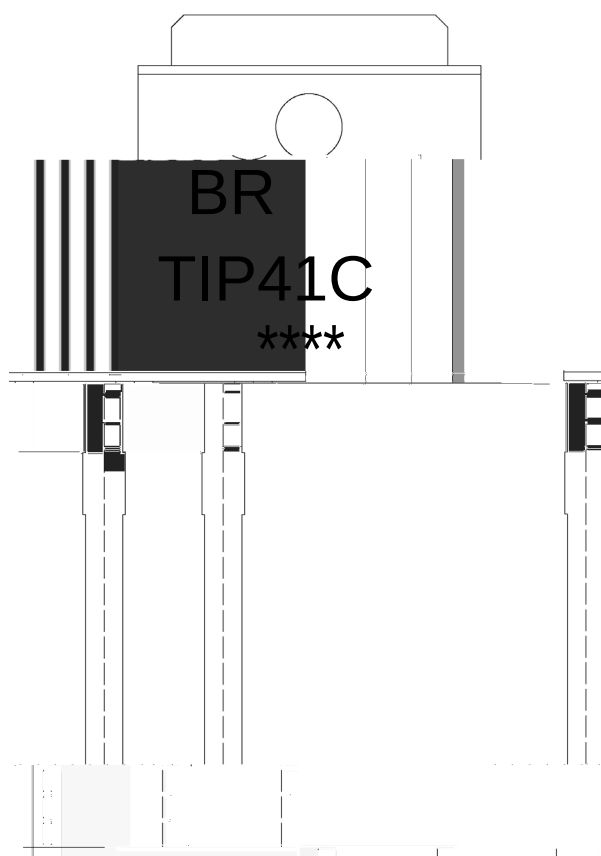
℥ˆˆ А І ' ı Ó Ą ħ Ẁ º

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	100	V
Collector to Emitter Voltage	V_{CEO}	100	V
Emitter to Base Voltage	V_{EBO}	5	V

/ Package Dimensions



/ Marking Instructions



б " X

EU X

WLS74F X

---- X

Note:

BR:

TIP41C:

****:

№ 3 M Пб

№ F β 3 N

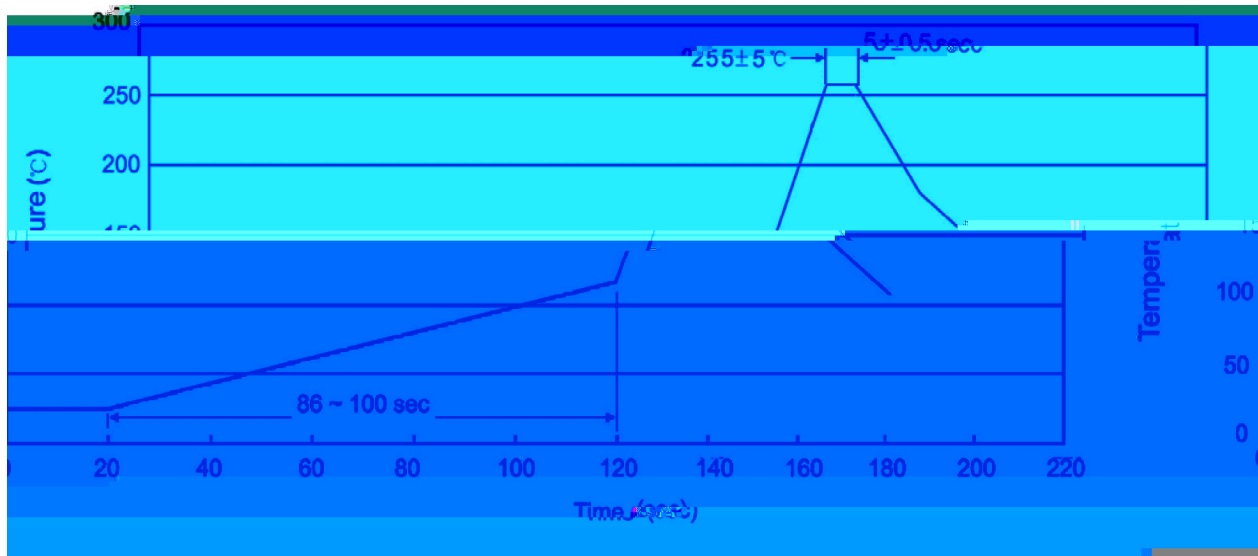
№ 1 F 1 N Пб 1 6 1 F 1 N Ψ p

Company Code

Product Type.

Lot No. Code, code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



说明

1. 预加热: 25~150℃, 时间: 60~90sec;
2. 峰值温度: 255±5℃, 时间: 5~0.5sec;
3. 冷却速度: 2~10℃/sec.

Note:

1. Preheating: 25~150℃, Time: 60~90sec.
2. Peak Temp.: 255±5℃, Duration: 5~0.5sec.
3. Cooling Speed: 2~10℃/sec.

/ Resistance to Soldering Heat Test Conditions

温度: 270±5℃ 时间: 10±1 sec. Temp.: 270±5 Time: 10±1 sec

/ Packaging SPEC.

散装 / BULK

Package Type	Units					Dimension (unit mm ³)		
	Units/Bag	Bags/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Bag	Inner Box	Outer Box
TO-251	1,000	10	10,000	5	50,000	135×190	237×172×102	560×245×195

管装 / TUBE

Package Type	Units	Dimension (unit mm ³)
Units/Tube		